关于本报告

“ ESG ”

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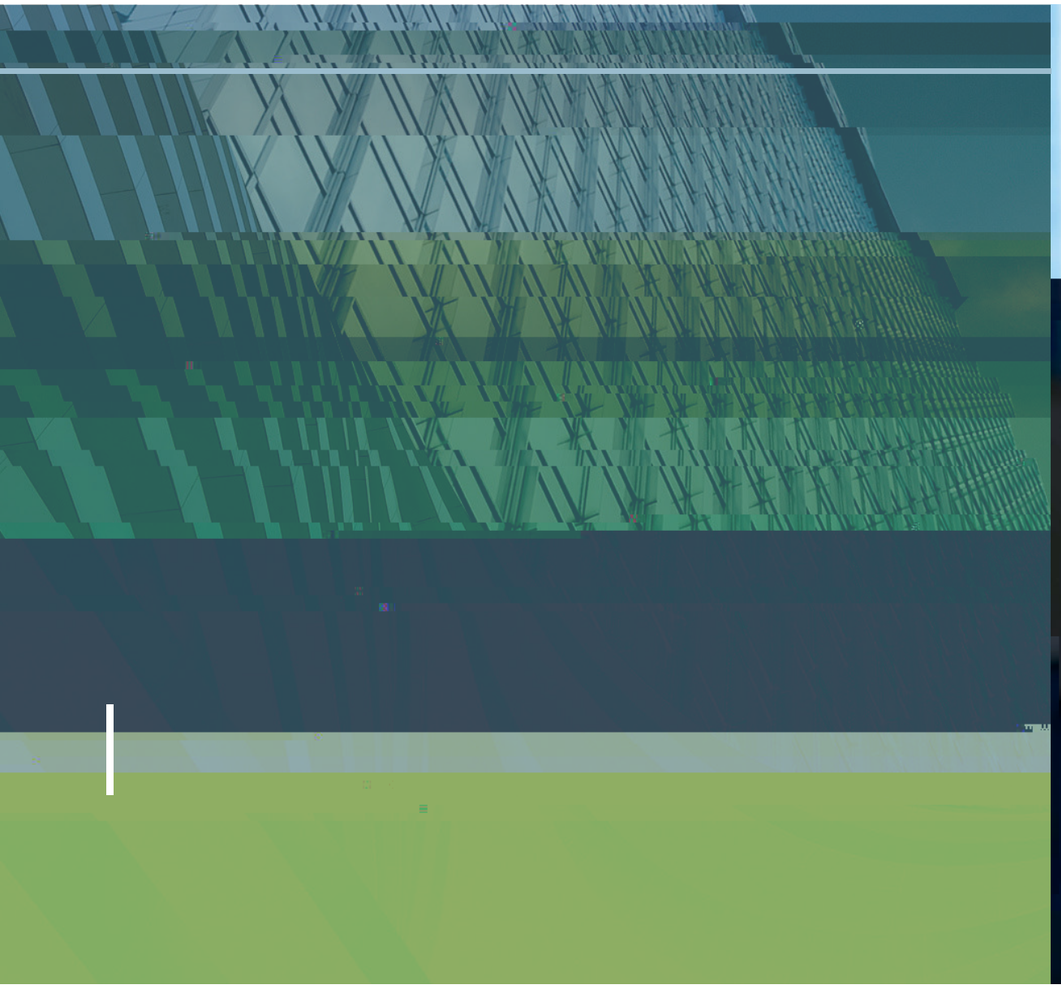
GSSB GRI

2016 “ ”

https://www.GigaDevice.com

目录

GRI



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MCU

NOR Flash NAND Flash MCU Arm MCU

MCU

SENSOR

DRAM

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NOR FLASH

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GD VF	RISC-V	ASPENCORE
GD LT		ASPENCORE
	IoT	
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GD E	/	ASPENCORE
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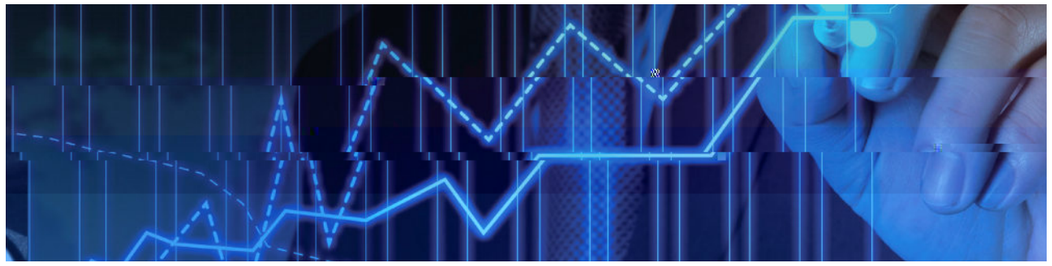
GD V MCU	IoT	
GD B/LB GE		ASPENCORE

2021



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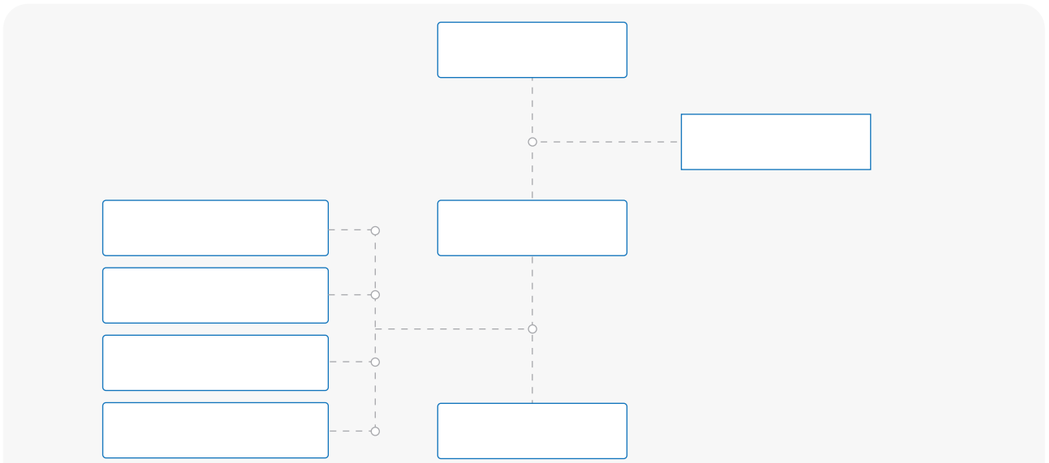

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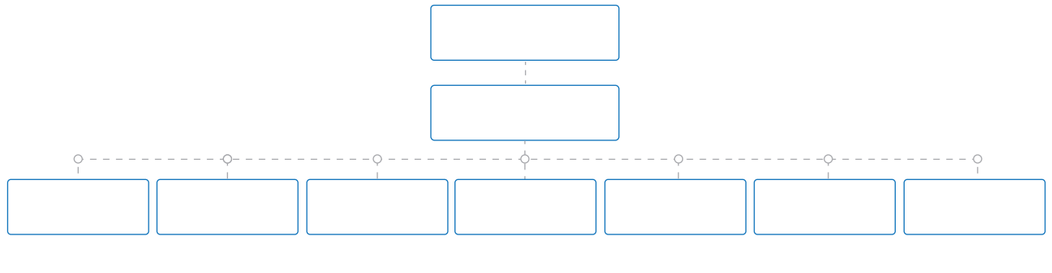
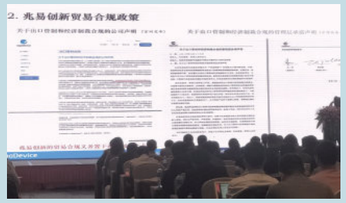
www.sse.com.cn -

IS GBT -



E-learning



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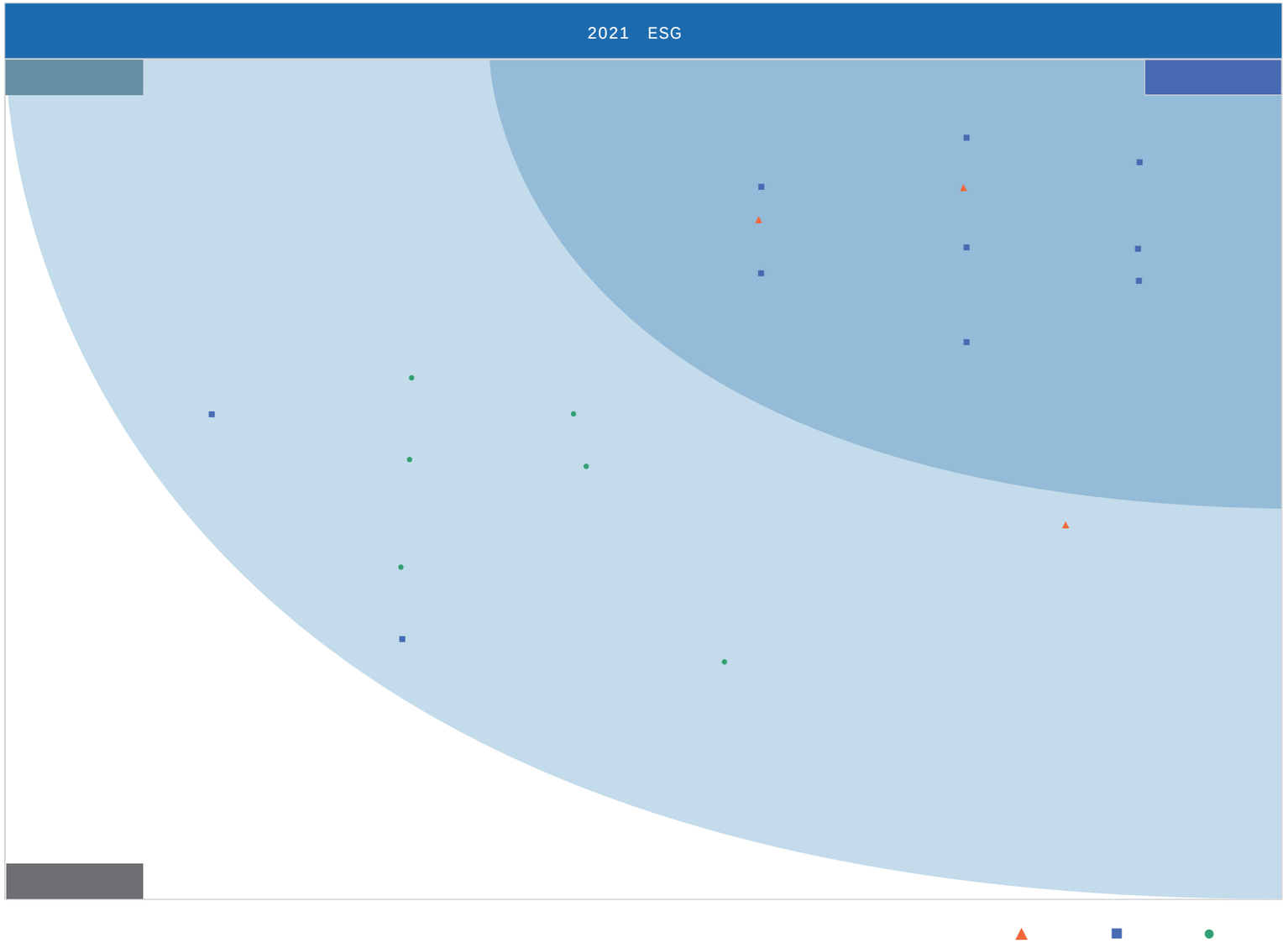

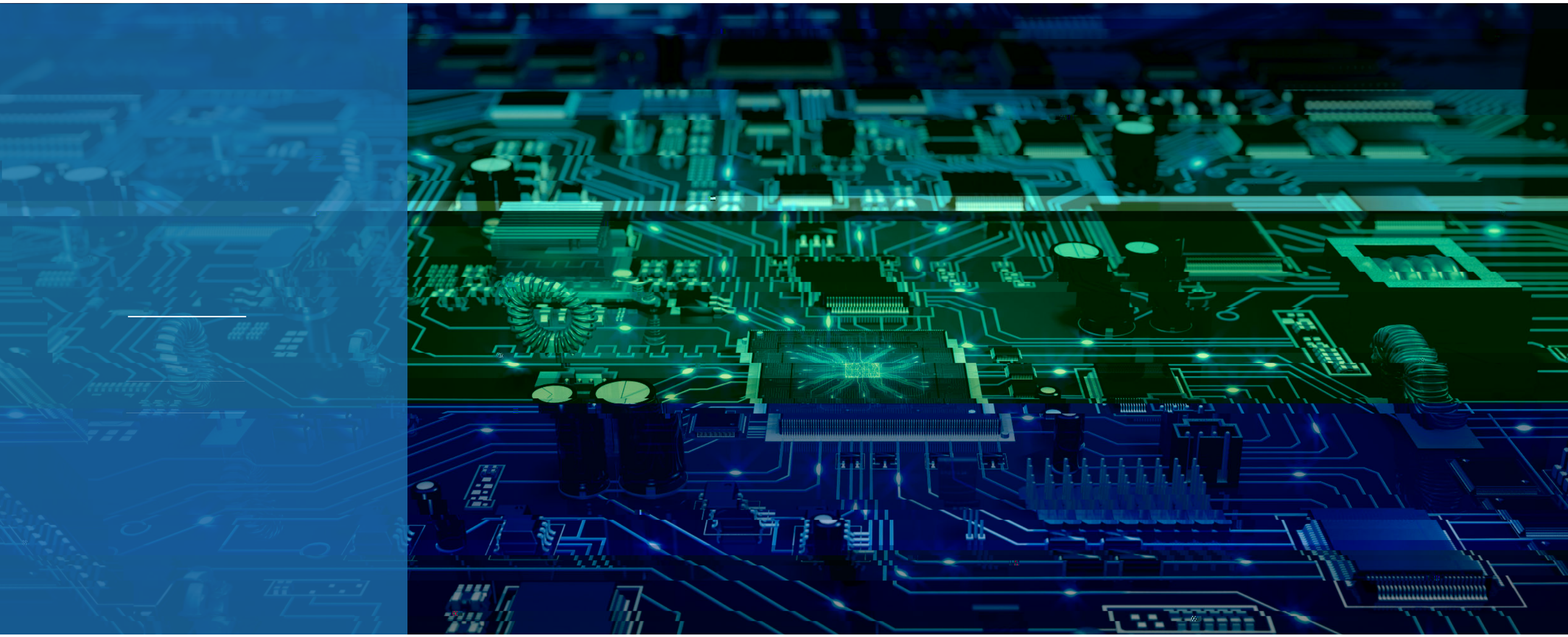

PC

NOR Flash Kb Gb

NAND Flash Gb- Gb

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GD / GD F

MCU

AEC-Q SPI NOR

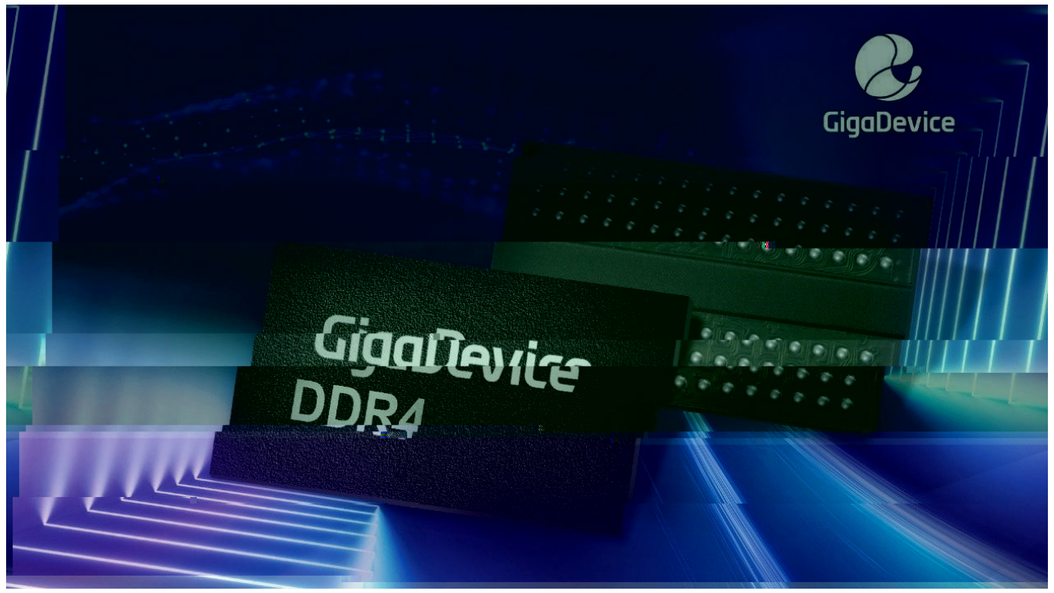
Flash SPI NAND Flash

DRAM

NOR Flash SLC NAND Flash DRAM

Gb DDR (nm

NOR Flash



Gb DDR GDQ BFAA

MCU

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MCU IoT MCU

IoT MCU “ MCU ”

MCU

Cortex-M Wi-Fi MCU

LCD LCD

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IoT

LCD OLED

ISO

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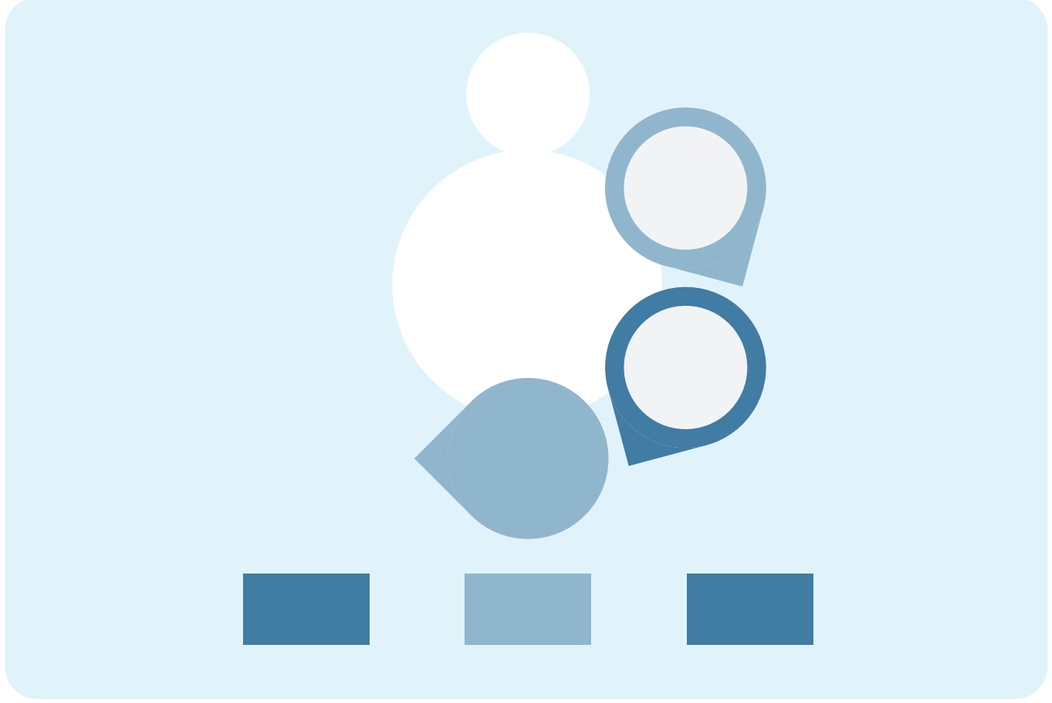
ISO



IPD Integrated Product Development

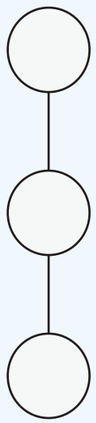
IPD

APQP

E-learning

E-Learning SQE CQE

RMA [1]



RMA [2]

1.RMA =RMA ÷ =

2.Return Material Authorization

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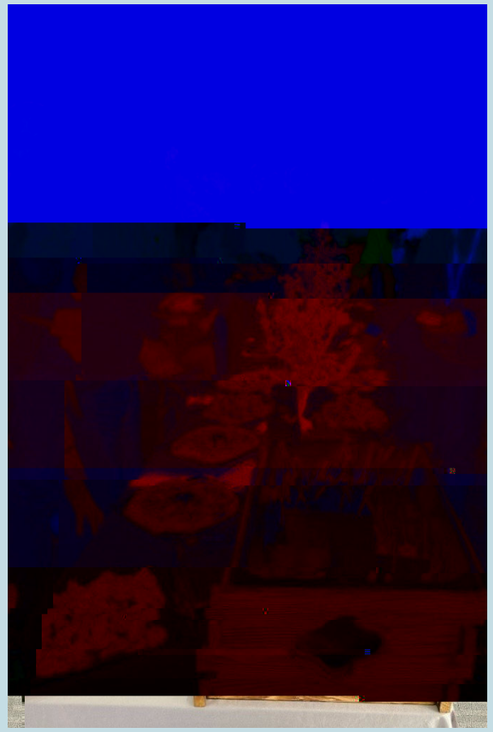

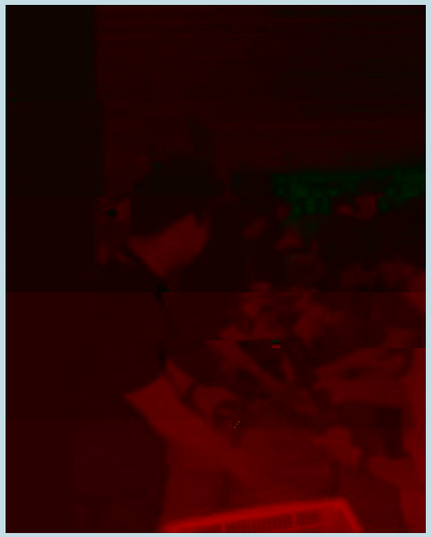

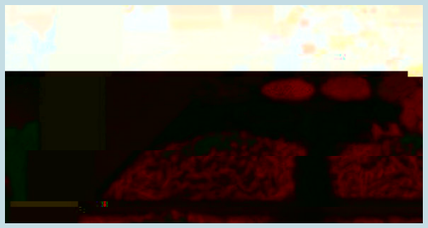

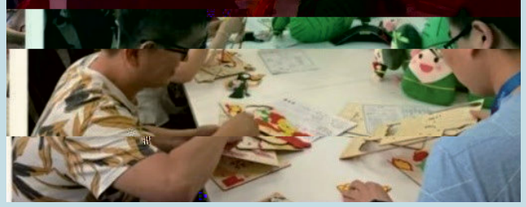

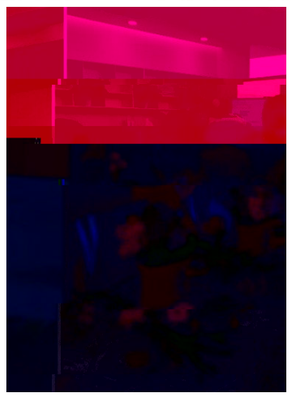

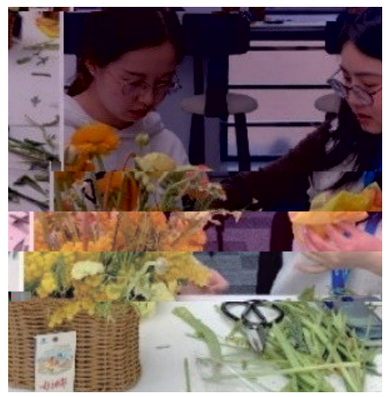

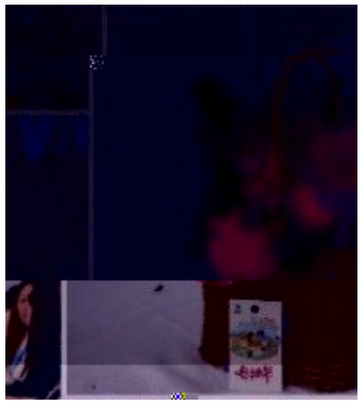

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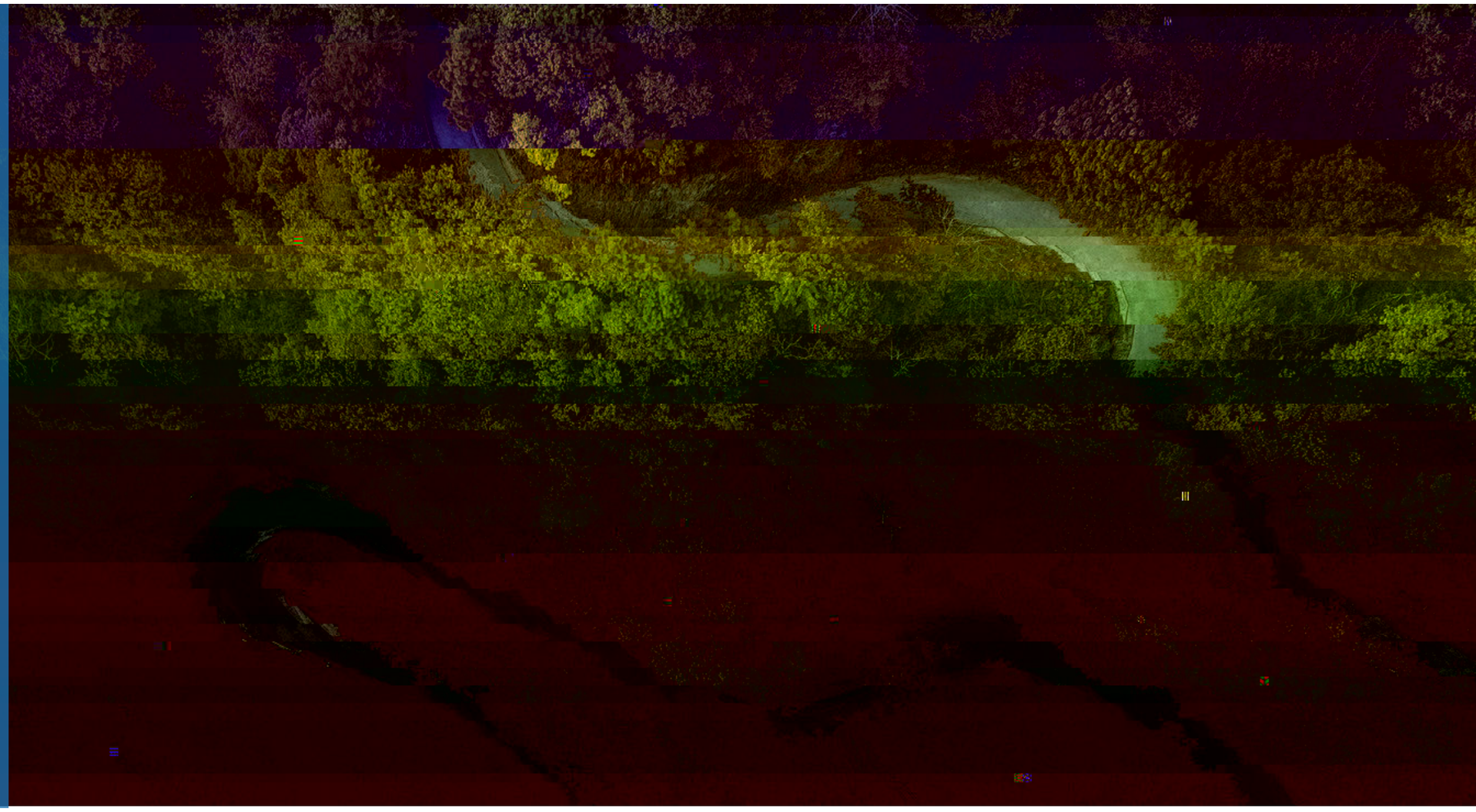

GigaDevice –

2021

项目	2021年6月		

ISO

证 书

北京美易创新科技股份有限公司

ISO 14001 : 2015

DQS GmbH

TCFD

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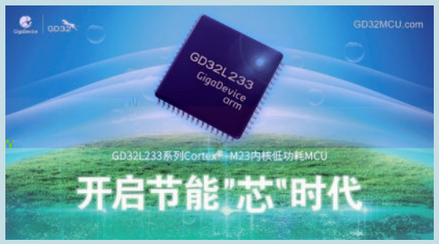
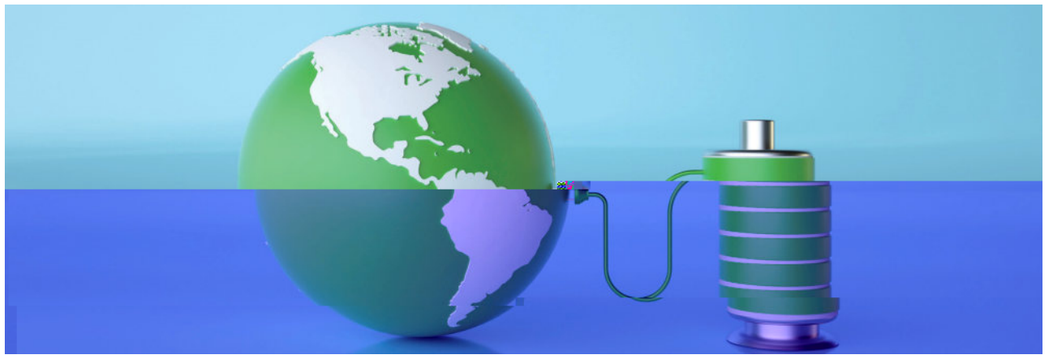


GD L MCU



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CMRT[9] CRT[10] EMRT[11]

9.Conflict Minerals Reporting Template CMRT RMI

10.Cobalt Reporting Template,

11.Extended Minerals Reporting Template (EMRT)

12.Quarterly Business Review

7.Responsible Business Alliance " " 2017 10 17 EICC Electronic Industry Citizenship Coalition
RBA RBA 6.0

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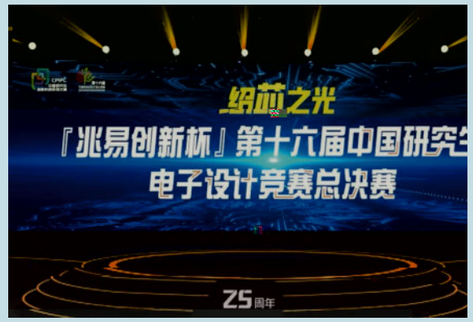

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“ + ” RISC - VMCU GD MCU

MCU SEGGER IAR Systems

GD MCU Arm®MCU oneNET AWS Azure

Arm®Cortex®-M /M /M /M MCU GD MCU

RISC-V MCU Embedded World

RISC-V

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* 以上为部分展示，更多GD32生态合作伙伴持续更新中
* 所有商标、Logo和品牌名称均为其各自所有者的财产

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EVB RTOS GUI GD

GD Azure

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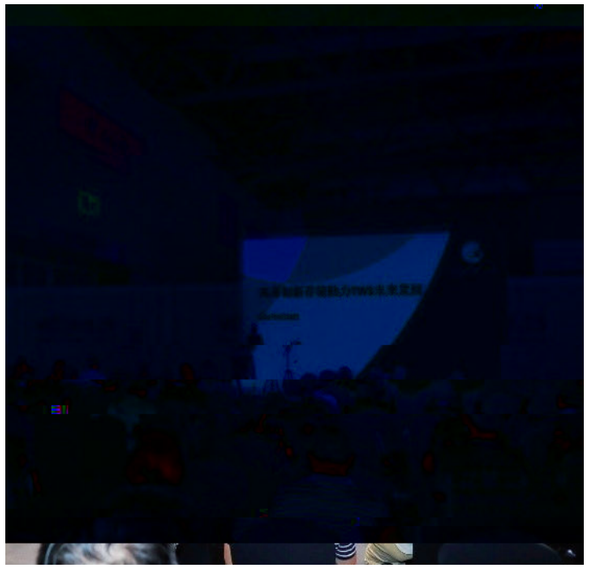
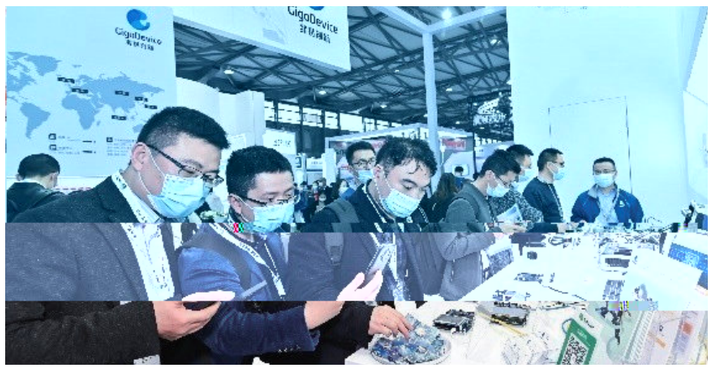


ELEXCON



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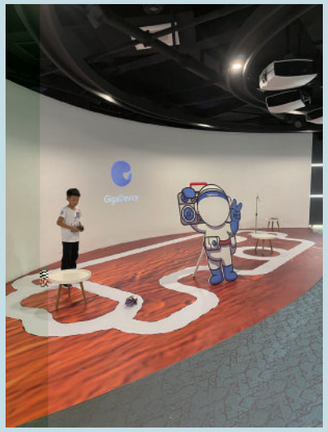

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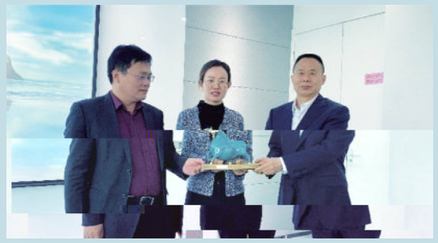

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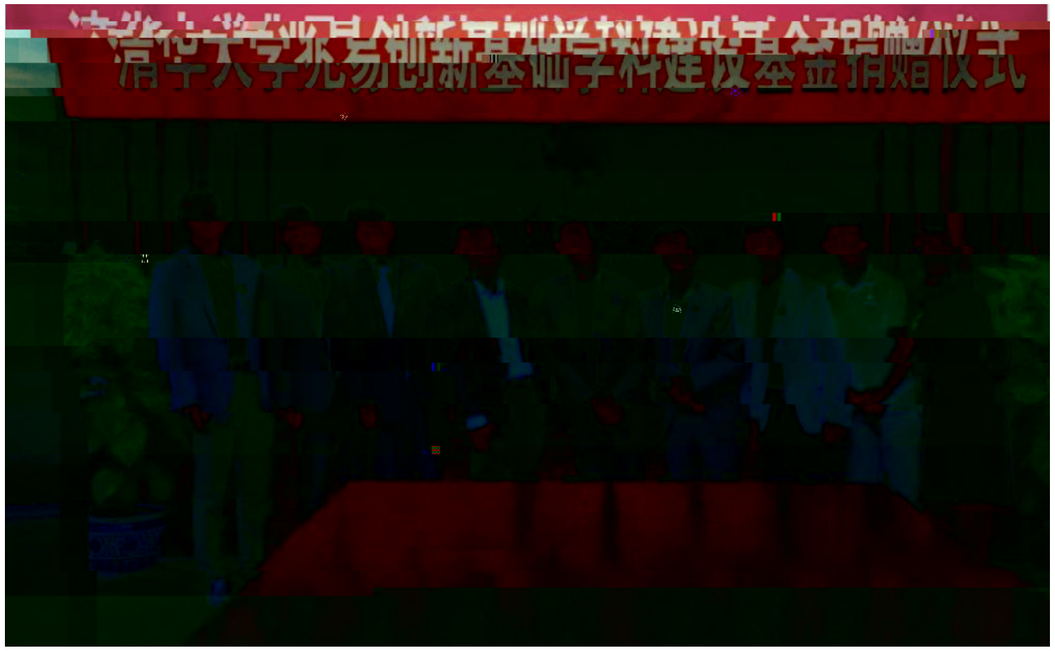

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